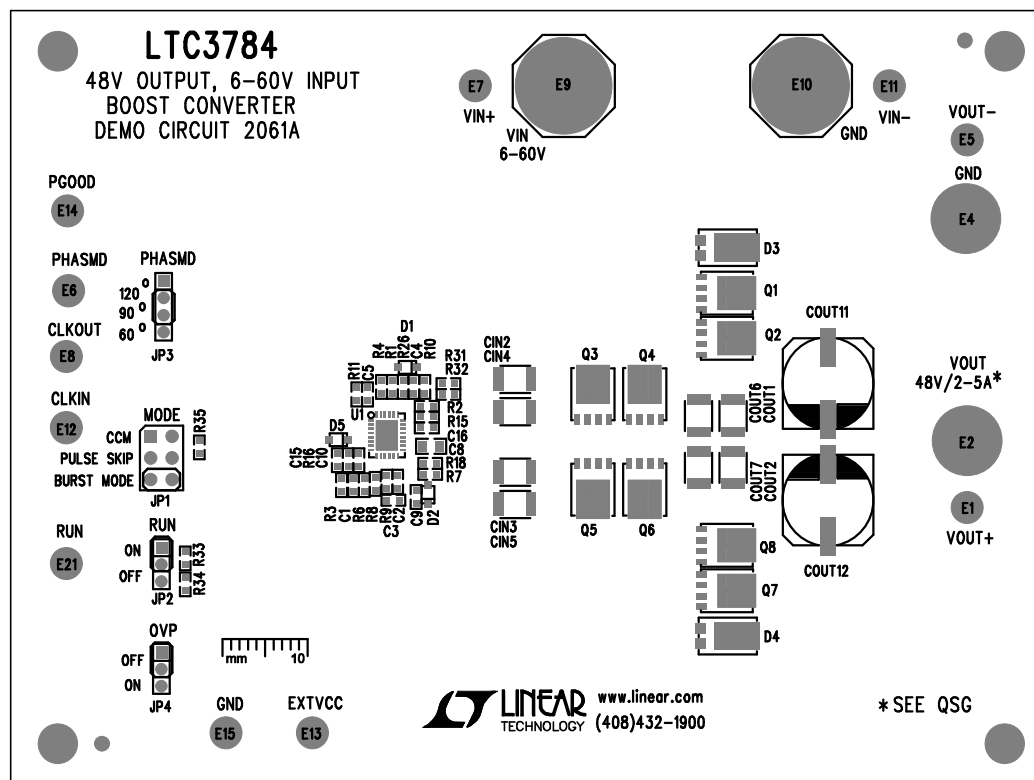
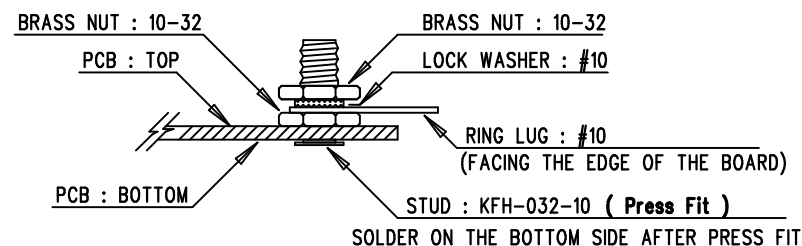
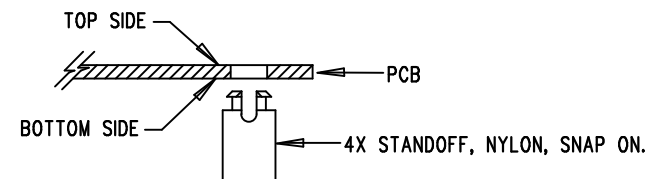


REVISION HISTORY				
ECO	REV	DESCRIPTION	APPR	DATE
-	2	PRODUCTION	GORAN P.	09-11-13



## NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD. MAXIMUM SOLDER TEMPERATURE IS 240 DEGREES CELSIUS.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. INSTALL SHUNTS AS SHOWN ON ASSY DRAWING.
5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
6. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD.
7. INSTALL STANDOFFS AND STUDS AS SHOWN BELOW:



SOLDER ON THE BOTTOM SIDE AFTER PRESS FIT

APPROVALS			
PCB DES.	LT		
APP ENG.	GORAN P.	<b>TITLE: TOP ASSEMBLY DRAWING</b> <b>48V OUTPUT, 6-60V INPUT</b> <b>BOOST CONVERTER</b>	
		SIZE N/A	IC NO. LTC3784IUF DEMO CIRCUIT 2061A
SCALE = NONE		FILENAME: DC2061A-2.PCB	REV. 2 SHT 1 OF 2

1630 MCCARTHY BLVD  
MILPITAS, CA 95035  
PH: (408)432-1900  
www.linear.com  
LTC CONFIDENTIAL-  
FOR CUSTOMER USE ONLY